

2SK2225 Silicon N Channel MOS FET

REJ03G1005-0200 (Previous: ADE-208-140) Rev.2.00 Sep 07, 2005

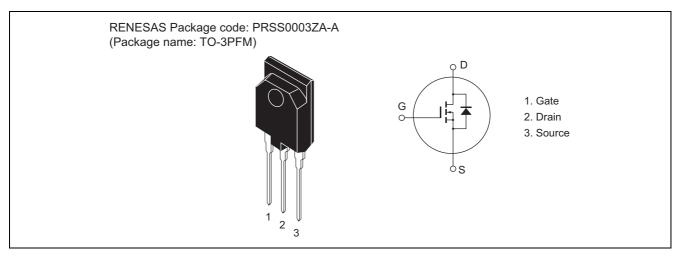
Application

High speed power switching

Features

- High breakdown voltage ($V_{DSS} = 1500 \text{ V}$)
- High speed switching
- Low drive current
- No Secondary breakdown
- Suitable for switching regulator, DC-DC converter

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	1500	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	2	A
Drain peak current	I _{D(pulse)} * ¹	7	A
Body to drain diode reverse drain current	I _{DR}	2	A
Channel dissipation	Pch*2	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at $Tc = 25^{\circ}C$

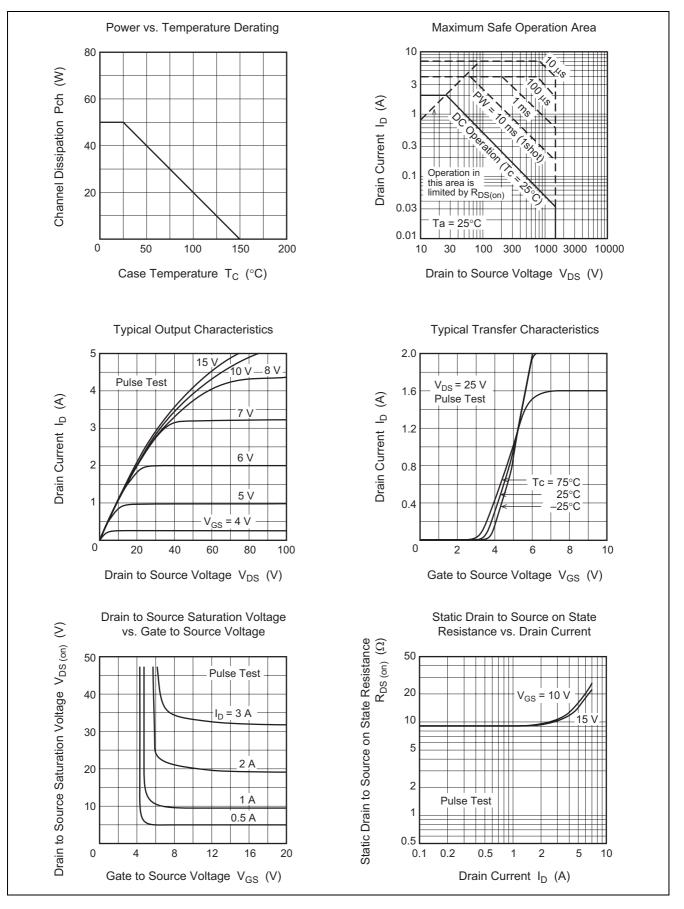
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	1500	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	—	±1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	—	500	μΑ	$V_{DS} = 1200 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	2.0	—	4.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS(on)}	_	9	12	Ω	$I_D = 1 \text{ A}, V_{GS} = 15 \text{ V}^{*3}$
Forward transfer admittance	y _{fs}	0.45	0.75	_	S	$I_D = 1 \text{ A}, V_{DS} = 20 \text{ V}^{*3}$
Input capacitance	Ciss	_	990	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss	_	125	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	60		pF	
Turn-on delay time	t _{d(on)}	_	17	_	ns	$I_D = 1 \text{ A}, V_{GS} = 10 \text{ V},$ $R_L = 30 \Omega$
Rise time	tr	_	50	—	ns	
Turn-off delay time	t _{d(off)}	_	150	—	ns	
Fall time	t _f	_	50	—	ns	
Body to drain diode forward voltage	V _{DF}		0.9		V	$I_F = 2 A, V_{GS} = 0$
Body to drain diode reverse	t _{rr}		1750		ns	$I_F = 20 \text{ A}, V_{GS} = 0,$
recovery time						$di_F / dt = 100 \text{ A} / \mu \text{s}$

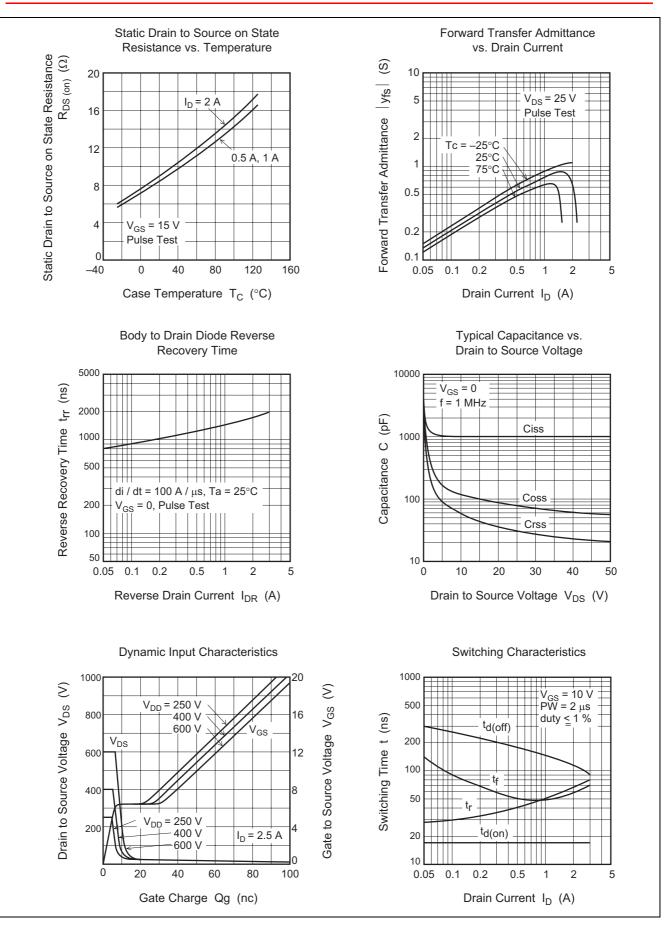
Note: 3. Pulse Test



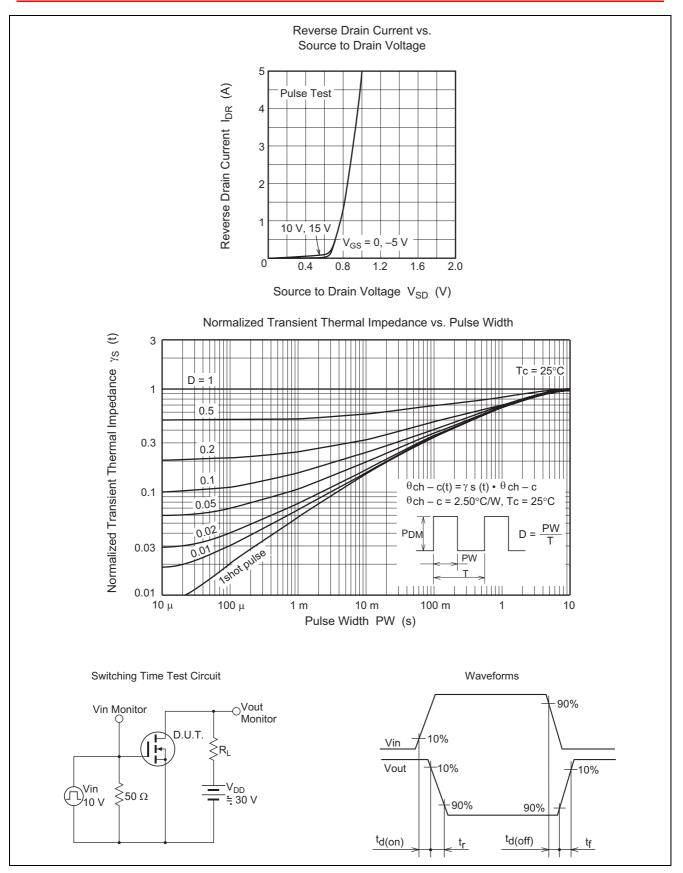
Main Characteristics



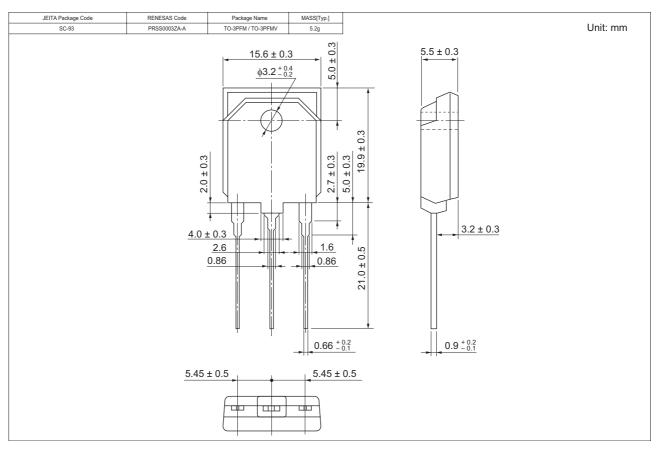








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK2225-E	360 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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